

CX18 NO CLEAN CORED WIRE SOLDER

FEATURES

- Fast Wetting
- Minimal/Clear Residue
- Extends Solder Tip Life
- ROL0 per IPC J-STD-004
- REACH and RoHS Compliant*
- Low Odor / Fumes

DESCRIPTION

CX18 is a no clean flux core wire solder designed to offer excellent soldering results with all alloys and on all surface finishes. Engineered for high operator satisfaction CX18 is a low odor/smoke formula which promotes thermal transfer, and fast wetting without the need for additional flux. CX18 post solder residues are minimal, clear and pass IPC-004A and IPC-004B SIR and corrosion requirements.

STANDARD AVAILABILITY

CX18 is available in multiple lead-free alloys. Additional alloys and diameters may be available upon request.

APPLICATION

Best results are obtained with a properly sized solder iron tip at a temperature between $300^{\circ} - 400^{\circ}C (575^{\circ} - 750^{\circ}F)$ for leaded alloys and $370^{\circ} - 425^{\circ}C (700^{\circ} - 800^{\circ}F)$ for lead-free alloys. If additional flux is required AIM NC280 liquid flux or NC217 gel flux are recommended.

*Lead-free.



HANDLING & STORAGE

Time	Parameters		
7 Years	< 85°F (< 29°C)		

Store cor	ed wire	in a	clean,	dry	area	away	from	moisture	and
sunlight.	Do not t	freez	e this p	produ	uct.				

CLEANING

CX18 can be cleaned with commercially available flux removers. IPA is not recommended. Contact AIM for specific information.

SAFETY

Use with adequate ventilation and proper personal protective equipment. Refer to the accompanying Safety Data Sheet for any specific emergency information. Do not dispose of any hazardous materials in non-approved containers.

*All information for reference only. Not to be used as incoming product specifications or for process design. Consult Certificate of Analysis for product specific information.

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TECHNICAL DATA SHEET



TEST DATA SUMMARY

Name	Test Method	Results				
IPC Flux Classification	J-STD-004	ROL0				
IPC Flux Classification	J-STD-004B 3.3.1	ROL1				
Name	Test Method	Typical Results	Image			
Copper Mirror	J-STD-004B 3.4.1.1 IPC-TM-650 2.3.32	LOW				
Corrosion	J-STD-004B 3.4.1.2 IPC-TM-650 2.6.15	PASS				
Quantitative Halides	J-STD-004B 3.4.1.3 IPC-TM-650 2.3.28.1	0.09% Typical				
Qualitative Halides, Silver Chromate	J-STD-004B 3.5.1.1 IPC-TM-650 2.3.33	PASS				
Qualitative Halides, Fluoride Spot	J-STD-004B 3.5.1.2 IPC-TM-650 2.3.35.1	No Fluoride	PASS			
Surface Insulation Resistance	J-STD-004B 3.4.1.4 IPC-TM-650 2.6.3.7	PASS	$ \begin{array}{c} 13 \\ 12 \\ 11 \\ 10 \\ 10 \\ 10 \\ 10 \\ 10 \\ 10$			
Acid Value Determination	J-STD-004B 3.4.2.2 IPC-TM-650 2.3.13	156 mg KOH/g flux Typical				

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